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April 1<sup>st</sup>, 2010 Renesas Electronics Corporation

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# 2SK2202

## Silicon N Channel MOS FET

REJ03G1002-0300

(Previous: ADE-208-139)

Rev.3.00 Sep 07, 2005

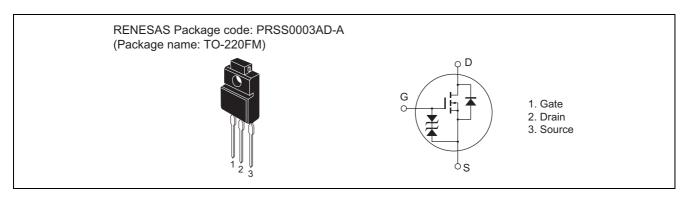
### **Application**

High speed power switching

#### **Features**

- Low on-resistance
- High speed switching
- Low drive current
- 4 V gate drive device can be driven from 5 V source
- Suitable for switching regulator, DC-DC converter

#### **Outline**



## **Absolute Maximum Ratings**

 $(Ta = 25^{\circ}C)$ 

| Item                                      | Symbol                   | Ratings     | Unit |
|---|--------------------------|-------------|------|
| Drain to source voltage                   | V <sub>DSS</sub>         | 120         | V    |
| Gate to source voltage                    | V <sub>GSS</sub>         | ±20         | V    |
| Drain current                             | I <sub>D</sub>           | 7           | Α    |
| Drain peak current                        | I <sub>D(pulse)</sub> *1 | 14          | Α    |
| Body to drain diode reverse drain current | I <sub>DR</sub>          | 7           | Α    |
| Channel dissipation                       | Pch*2                    | 20          | W    |
| Channel temperature                       | Tch                      | 150         | °C   |
| Storage temperature                       | Tstg                     | -55 to +150 | °C   |

Notes: 1. PW  $\leq$ 10  $\mu$ s, duty cycle  $\leq$  1 %

2. Value at Tc = 25°C

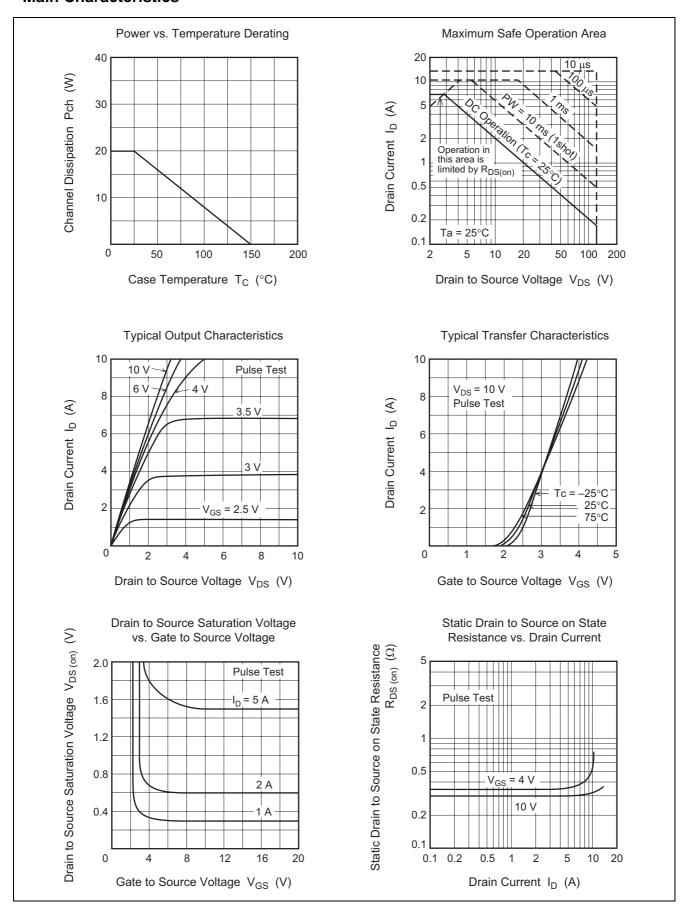
### **Electrical Characteristics**

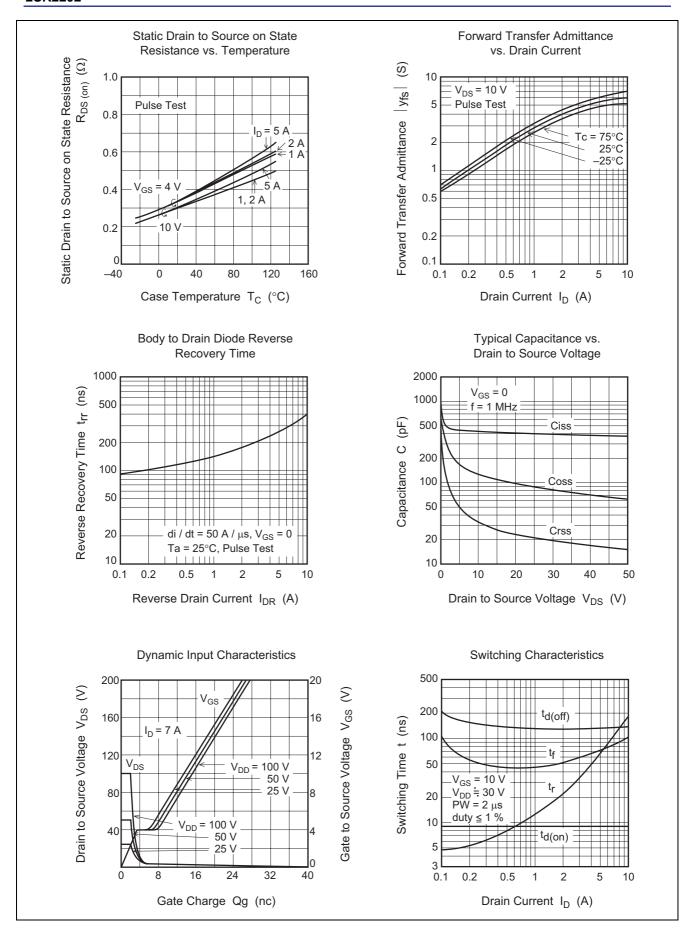
 $(Ta = 25^{\circ}C)$ 

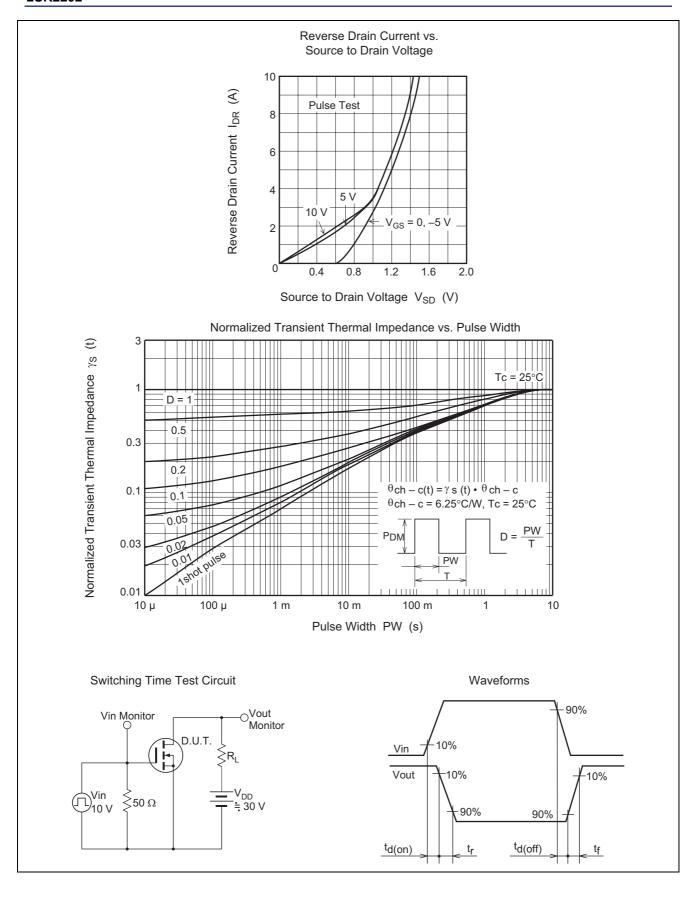
| Item                                | Symbol              | Min | Тур  | Max  | Unit | Test conditions                                 |
|-------------------------------------|---------------------|-----|------|------|------|---|
| Drain to source breakdown voltage   | $V_{(BR)DSS}$       | 120 | _    | _    | V    | $I_D = 10 \text{ mA}, V_{GS} = 0$               |
| Gate to source breakdown voltage    | $V_{(BR)GSS}$       | ±20 | _    | _    | V    | $I_G = \pm 100 \ \mu A, \ V_{DS} = 0$           |
| Gate to source leak current         | I <sub>GSS</sub>    | _   | _    | ±10  | μΑ   | $V_{GS} = \pm 16 \text{ V}, V_{DS} = 0$         |
| Zero gate voltage drain current     | I <sub>DSS</sub>    | _   |      | 250  | μΑ   | $V_{DS} = 100 \text{ V}, V_{GS} = 0$            |
| Gate to source cutoff voltage       | $V_{GS(off)}$       | 1.0 | _    | 2.0  | V    | $I_D = 1 \text{ mA}, V_{DS} = 10 \text{ V}$     |
| Static drain to source on state     | R <sub>DS(on)</sub> | _   | 0.3  | 0.4  | Ω    | $I_D = 4 \text{ A}, V_{GS} = 10 \text{ V}^{*3}$ |
| resistance                          |                     | _   | 0.35 | 0.55 | Ω    | $I_D = 4 \text{ A}, V_{GS} = 4 \text{ V}^{*3}$  |
| Forward transfer admittance         | y <sub>fs</sub>     | 3.0 | 5.0  | _    | S    | $I_D = 4 \text{ A}, V_{DS} = 10 \text{ V}^{*3}$ |
| Input capacitance                   | Ciss                | _   | 420  | _    | pF   | $V_{DS} = 10 \text{ V}, V_{GS} = 0,$            |
| Output capacitance                  | Coss                | _   | 140  | _    | pF   | f = 1 MHz                                       |
| Reverse transfer capacitance        | Crss                | _   | 35   | _    | pF   |   |
| Turn-on delay time                  | t <sub>d(on)</sub>  | _   | 9    | _    | ns   | $I_D = 4 \text{ A}, V_{GS} = 10 \text{ V},$     |
| Rise time                           | t <sub>r</sub>      | _   | 50   | _    | ns   | $R_L = 7.5 \Omega$                              |
| Turn-off delay time                 | t <sub>d(off)</sub> | _   | 140  | _    | ns   |   |
| Fall time                           | t <sub>f</sub>      | _   | 65   | _    | ns   |   |
| Body to drain diode forward voltage | $V_{DF}$            | _   | 1.35 | _    | V    | $I_F = 7 \text{ A}, V_{GS} = 0$                 |
| Body to drain diode reverse         | t <sub>rr</sub>     | _   | 320  | _    | ns   | $I_F = 7 \text{ A}, V_{GS} = 0,$                |
| recovery time                       |                     |     |      |      |      | $di_F / dt = 50 A / \mu s$                      |

Note: 3. Pulse Test

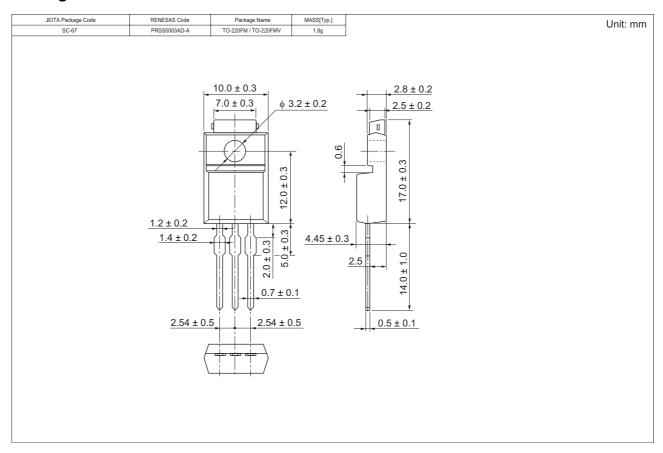
### **Main Characteristics**







### **Package Dimensions**



### **Ordering Information**

| Part Name | Quantity | Shipping Container |
|-----------|----------|--------------------|
| 2SK2202-E | 500 pcs  | Box (Sack)         |

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